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PATENT APPLICATION
Do. No. 9898-199

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Jung-Hwan CHOI

Serial No. 09/978,497

Examiner: Pierre, Kenelt

Filed: October 16, 2001

Group Art Unit: 2822

For: SOCKETS FOR MODULE EXTENSION AND MEMORY SYSTEM
USING THE SAME

BOX NON FEE AMENDMENT
Assistant Commissioner for Patents
Washington, D.C. 20231

RECEIVED
JUL 11 2002
TC 2800
C/A 7/10/02
A. Wellen

RESPONSE TO OFFICE ACTION

Responsive to the Office Action, dated March 28, 2002, please amend the application as follows.

IN THE CLAIMS

Please amend the claims by rewriting as follows:

1. A through socket comprising:

a socket body arranged to load first and second memory modules;

a first conductor arranged to connect a contact on one surface of the first memory module to a contact on one surface of the second memory module; and

a second conductor arranged to connect a contact on the other surface of the first memory module to a contact on the other surface of the second memory module.

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01 FC:102

2. The through socket of claim 1, wherein the socket body is arranged to load the first and second memory modules in the same direction.

3. The through socket of claim 1, wherein the socket body is arranged to load the first and second memory modules in opposite directions.

07/10/2002 ANAB11 00000015 09978497
01 FC:103
02 FC:102
162.00 DP
84.00 DP